US0D1040117S

(12) United States Design Patent

Chan et al.

(10) Patent No.: US D1,040,117 S
(45) Date of Patent: ** Aug. 27, 2024

(54) **LIGHT-EMITTING DIODE DEVICE**

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(73) Assignee: **EPISTAR CORPORATION**, Hsinchu (TW)

(**) Term: **15 Years**

(21) Appl. No.: **29/915,273**

(22) Filed: **Oct. 27, 2023**

Related U.S. Application Data

(62) Division of application No. 29/822,281, filed on Jan. 7, 2022, now Pat. No. Des. 1,008,198.

(30) **Foreign Application Priority Data**

Jul. 9, 2021 (TW) 110303585

(51) **LOC (14) Cl.** **13-03**

(52) **U.S. Cl.**
USPC **D13/180**

(58) **Field of Classification Search**
USPC D13/180, 182; D26/1
CPC H01L 27/15; H01L 27/156; H01L 33/08; H01L 33/10; H01L 33/20; H01L 33/38; H01L 33/42; H01L 33/48; H01L 33/483; H01L 33/486; H01L 2223/5441; H01L 2223/54433; H01L 25/167; H01L 25/0753
See application file for complete search history.

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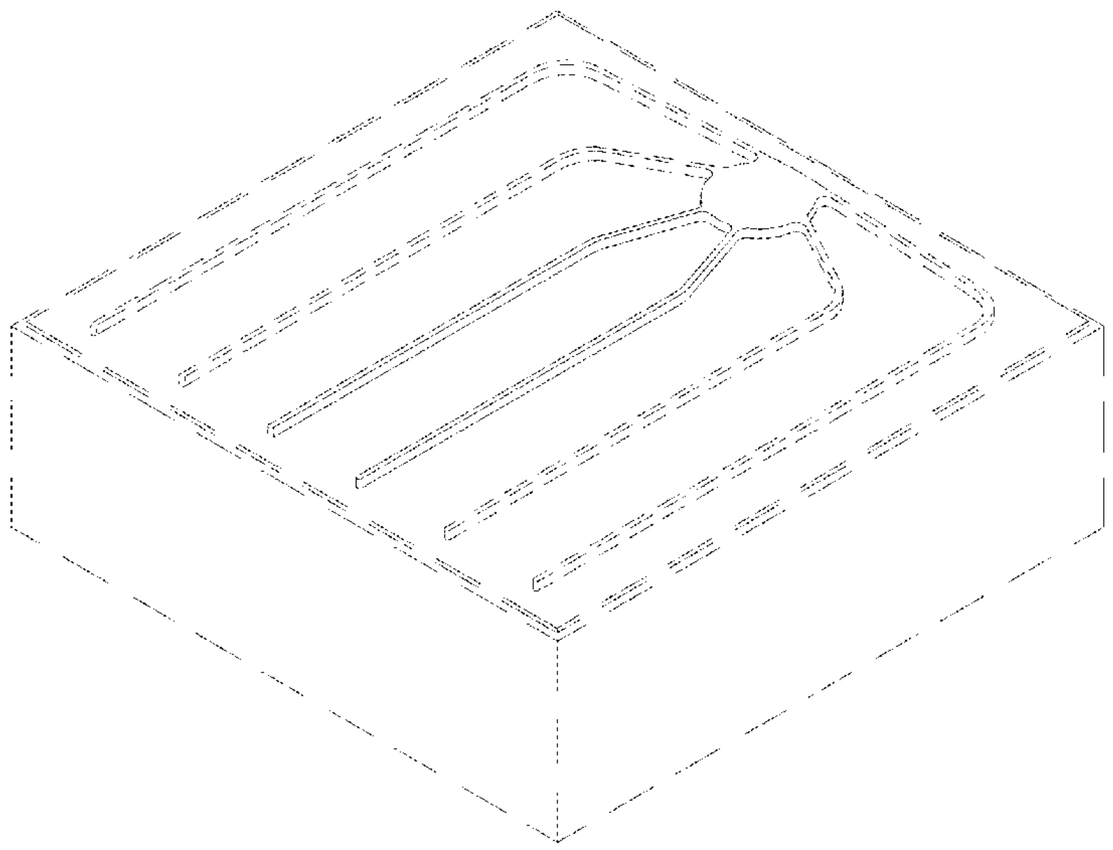
(57) **CLAIM**

The ornamental design for a light-emitting diode device, as shown and described.

DESCRIPTION

FIG. **1** is a perspective view of a light-emitting diode device showing our new design;
FIG. **2** is a front elevational view thereof;
FIG. **3** is a rear elevational view thereof;
FIG. **4** is a left side elevational view thereof;
FIG. **5** is a right side elevational view thereof;
FIG. **6** is a top plan view thereof; and,
FIG. **7** is a bottom plan view thereof.
The broken line showing is for the purpose of illustrating environmental structure only and forms no part of the claimed design.

1 Claim, 5 Drawing Sheets



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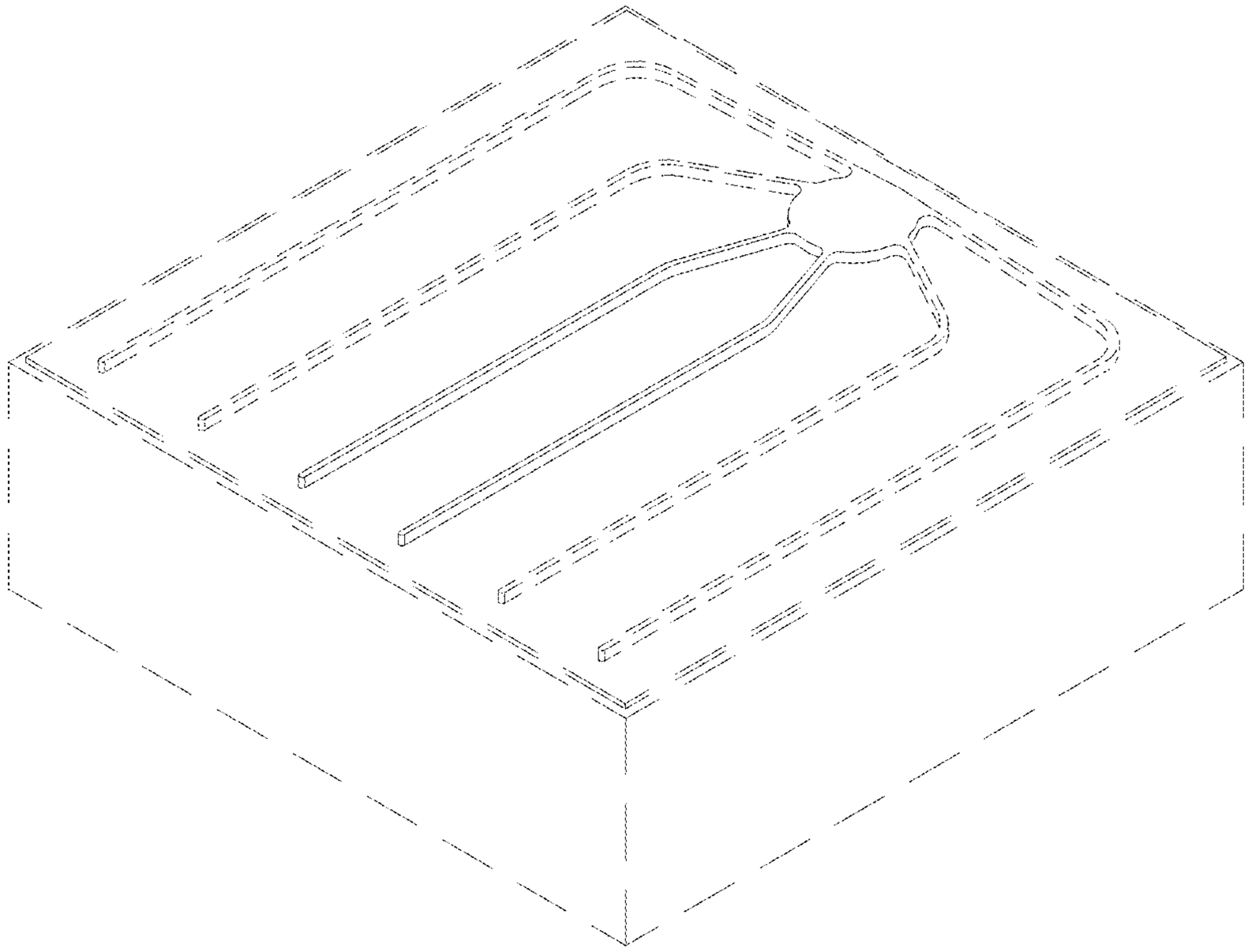

FIG. 1

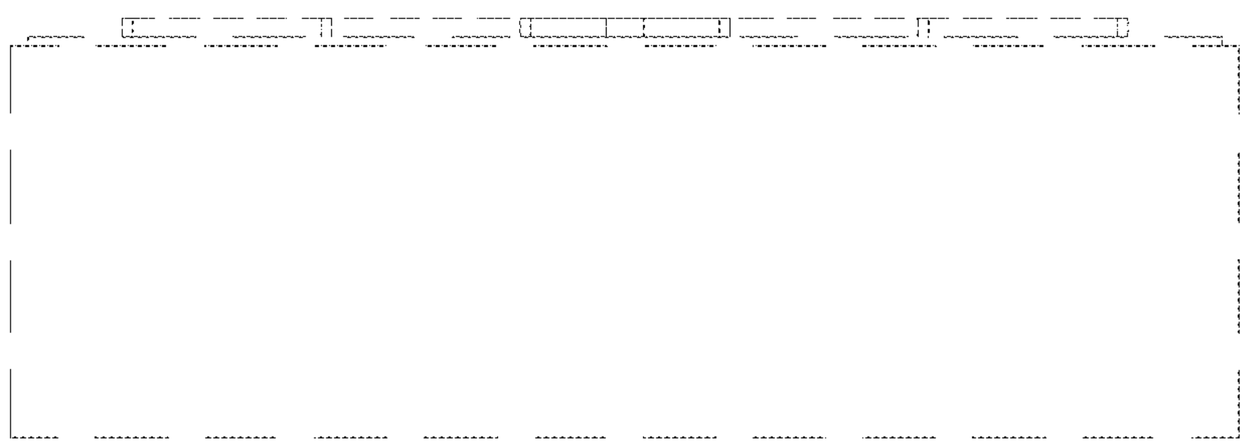

FIG. 2

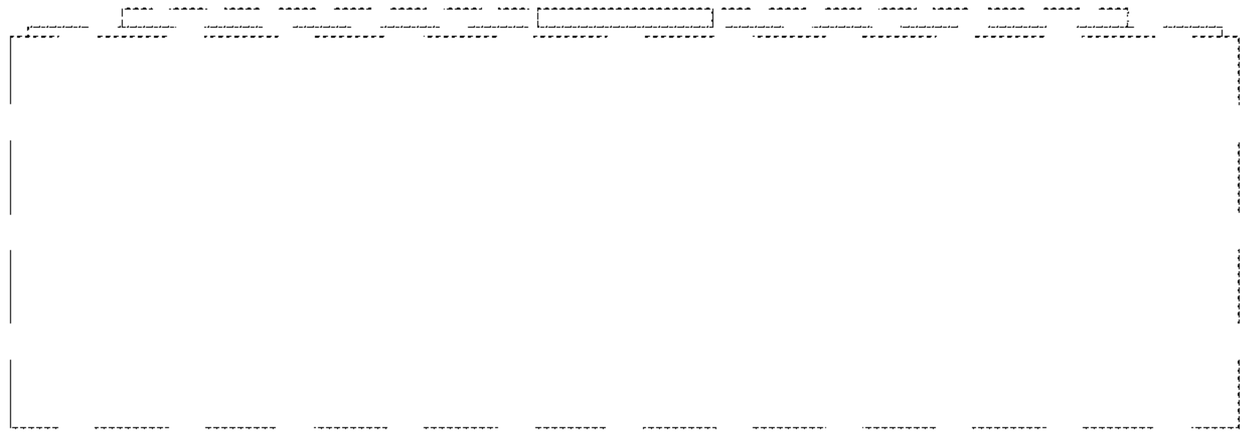

FIG. 3

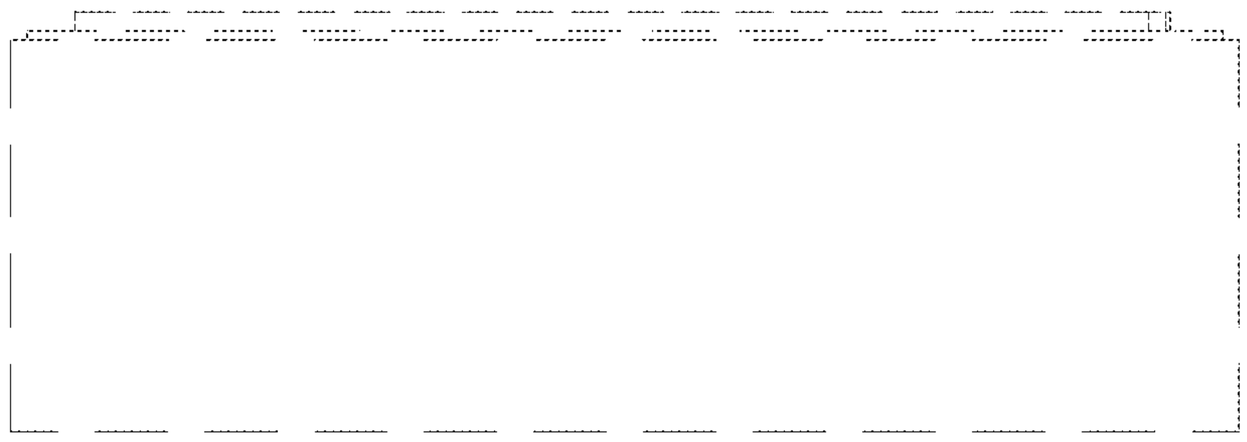

FIG. 4

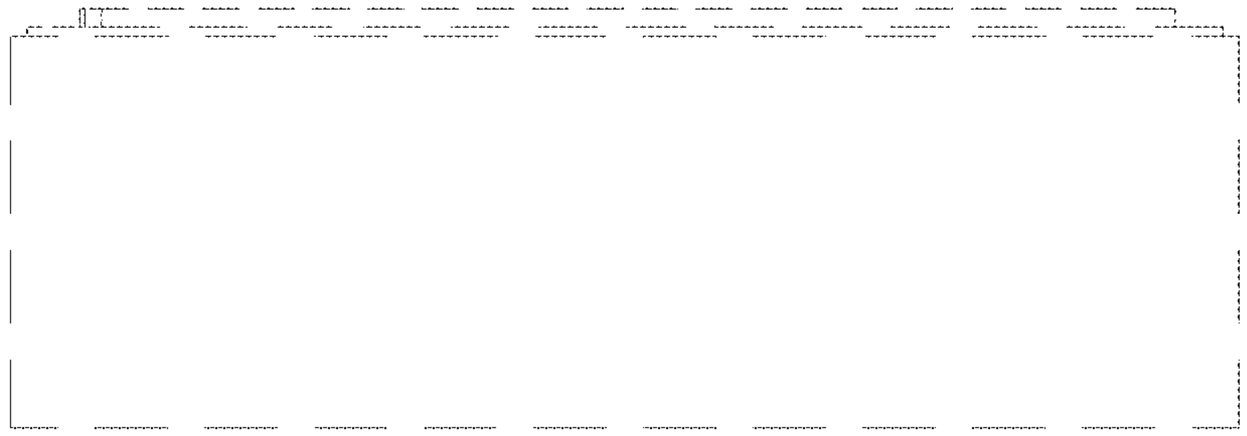

FIG. 5

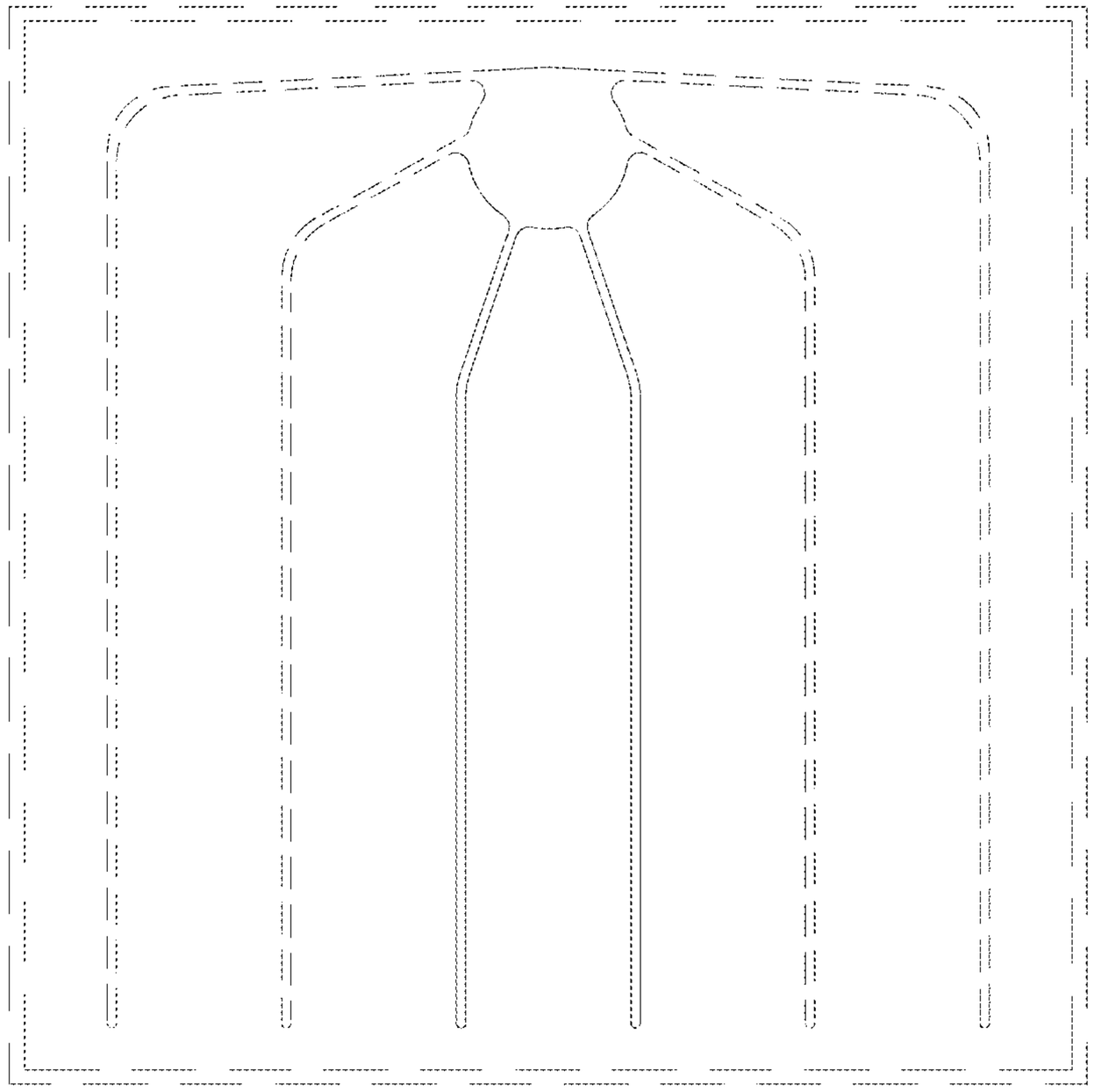

FIG. 6

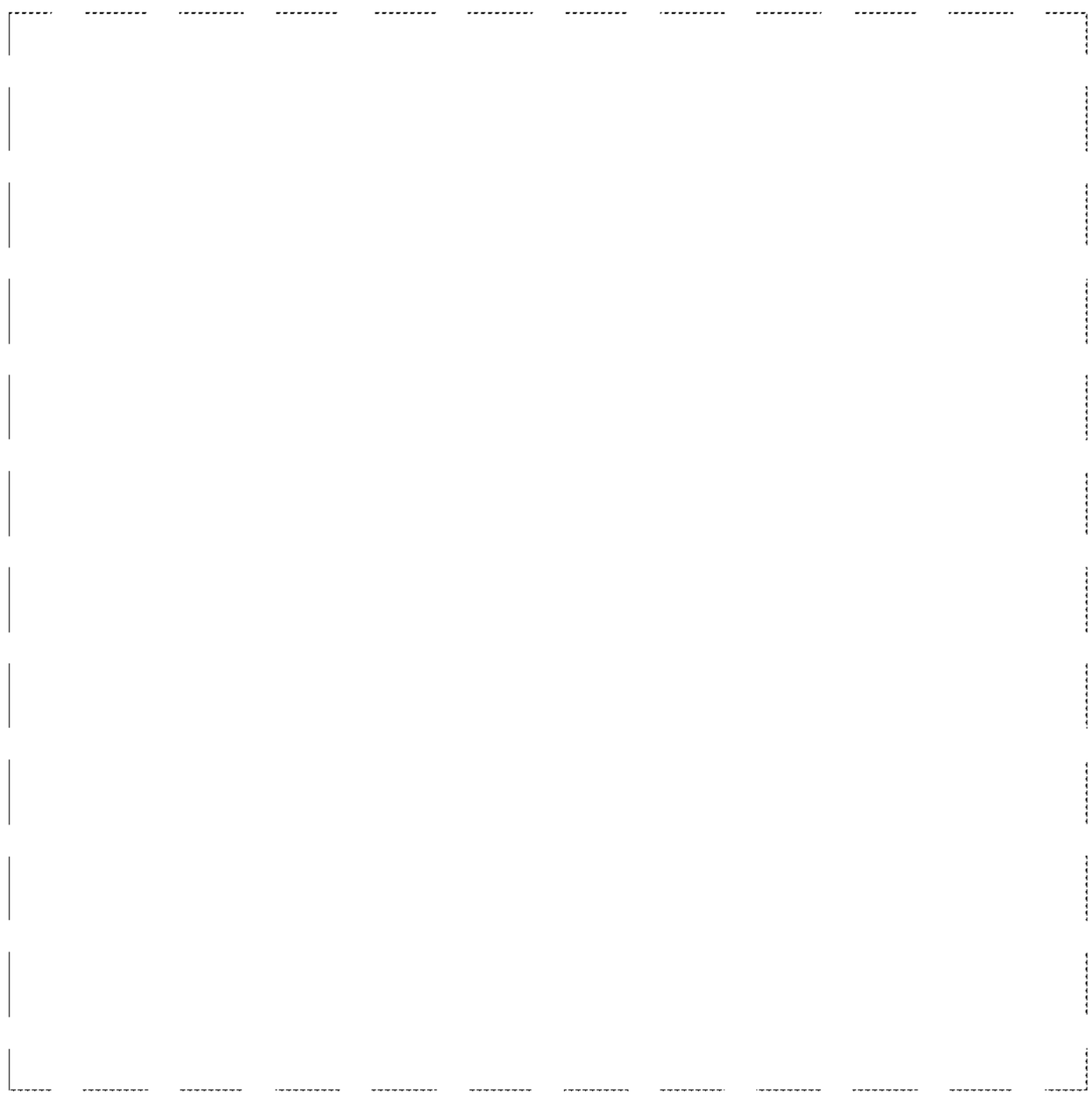

FIG. 7